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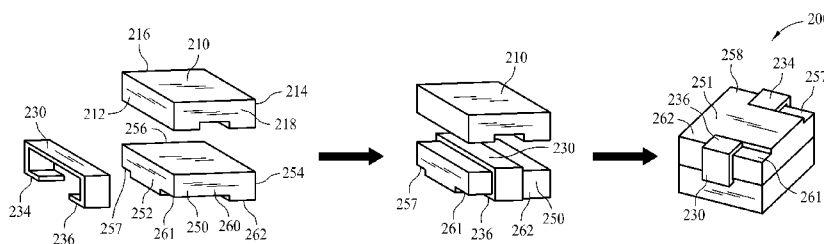


FIG. 2

(57) Abstract: Magnetic components including pre-formed clips (230) are described that are more amenable to production on a miniaturized scale. Discrete core pieces (210, 250) can be assembled with pre-formed coils and physically gapped from one another with more efficient manufacturing techniques.